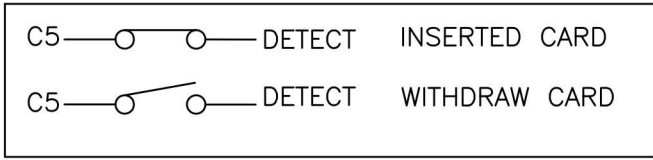


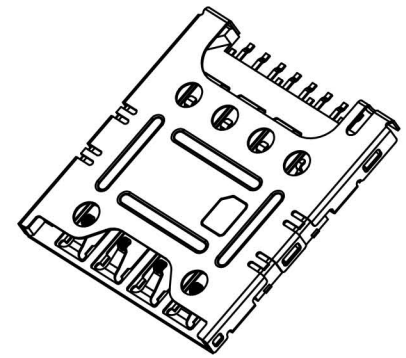
REV.	LOCAS.	DESCRIPTION	DRAW.	DATE.
01	NEW	INITIAL RELEASE.	Steven	2014.05.31

CONTACT AREA & SOLDER TAIL GOLD FLASH.



PIN ASSIGNMENTS

PIN	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED



- NOTES:
- MATERIAL:
 - 1.1 Housing:High Temperature Thermoplastic UL94V-0; Color Black.
 - 1.2 Terminal:Copper Alloy.
 - 1.3 Shell:Stainless Steel.
 - SPECIALITY:
 - 2.1 Rated current:0.5A MAX.
 - 2.2 Rated voltage:30V
 - 2.3 Contact Resistance:30mΩ MAX
 - 2.4 Insulation Resistance:1000MΩ MIN 500V DC
 - 2.5 Dielectric withstanding voltage: 100V AC.
 - 2.6 Solder ability:255±2°C, 5±0.5s.
 - 2.7 Durability:5000 Cycles Min.
 - 2.8 Operating condition:Temperature-30°C~+80°C; Humidity 80% R.H MAX

RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

MEASURE POINT:
 QUADRANT POINT (QP)
 TANGENCY POINT (TP)
 INTERSECTION POINT (IP)

UNLESS OTHERWISE SPECIFIED, TOLERANCE:
 X. ±0.25
 X.X ±0.20
 X.XX ±0.15
 ANGULAR ±3'

DESIGN	Steven	DATE	2014.05.31	TITLE:	
CHECKED		DATE		MICRO SIM CARD CONN H=1.24MM SMT TYPE	
APPROVED		DATE			
PART NO: A124-S0801A		REV: 01	SCALE: 3:1	UNIT: mm	
DRAWING NO: A124-S0801A		SIZE: A4	SHEET: 1/1		